

AF/2823

PATENT
Attorney Docket No. 3369.1US(91-365RE)

NOTICE OF EXPRESS MAILING

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Date of Deposit with USPS: April 8, 2002

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
BEFORE THE BOARD OF PATENT APPEALS AND INTERFERENCES

Serial No.: 09/023,146

Group Art Unit No.: 2823

Filing date: February 12, 1998

Examiner: T. Dang

For (title): TUNGSTEN SILICIDE (WSix) DEPOSITION PROCESS FOR SEMICONDUCTOR MANUFACTURE

TRANSMITTAL OF APPEAL BRIEF (PATENT APPLICATION – 37 C.F.R. § 192)

Commissioner of Patents and Trademarks
Washington, D.C. 20231

Sir:

1. Transmitted herewith in triplicate is the APPEAL BRIEF in this application with respect to the Notice of Appeal filed on February 7, 2002.

2. STATUS OF APPLICATION

This application is on behalf of

☒ other than a small entity
☐ small entity
 verified statement:
☐ attached
☐ already filed

3. FEE FOR FILING APPEAL BRIEF

Pursuant to 37 C.F.R. § 1.17(f) the fee for filing the Appeal Brief is:

<input type="checkbox"/>	small entity status	\$160
<input checked="" type="checkbox"/>	other than a small entity	\$320

4. EXTENSION OF TIME

☐ A petition for Extension of Time for a month extension of time for filing the Appeal Brief is enclosed.

5. FEE PAYMENT

☒ Check No. 2155 is enclosed in payment of the fee for filing the Appeal Brief plus any extension of time for which a petition has been filed.
☐ Please charge this fee to deposit account No. 20-1469 (a duplicate copy of this notice is enclosed--see below).

Any additional appeal fees which are not otherwise submitted herewith or which are insufficient should be charged to deposit account no. 20-146. A duplicate copy of this notice is enclosed. Please address all communications in connection with this appeal to the address indicated below. m

Respectfully submitted,

Devin R. Jensen

DEVIN R. JENSEN
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Date: April 8, 2002
Enclosures: As identified above

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